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(54) Lead frame for electroacoustic transducer and electroacoustic transducer

(57) A lead frame (1) for an electroacoustic transducer, forming leads of the electroacoustic transducer, comprising a metal sheet (2) made of a metal having elongation 20% or higher, a nickel undercoat deposit (3) of a thickness in the range from 0.01 to 2.0 μm formed on the metal sheet (2) by plating in a nickel plating bath containing no brightening agent, and a solder deposit (4) of a thickness in the range from 1.0 to 10 μm formed on the surface of the nickel undercoat deposit (3) by plating in a tin-lead plating bath containing no brightening agent. With the lead frame (1) formed by plating the metal sheet (2) as stated above, micro-cracking occurring in the bent corners of the metal sheet (2) and the solder deposit (4), when the outer leads of the lead frame (1) are bent at an angle of 90°, can be prevented.

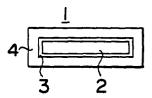


FIG. 3

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EUROPEAN SEARCH REPORT

Application Number EP 96 30 6415

Category	Citation of document with ine of relevant pass		Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int.Cl.6)	
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_		Date of completion of the search 13 February 1997	Ni	Examiner euwenhuis, P	
Y:pa	CATEGORY OF CITED DOCUMEN rticularly relevant if taken alone rticularly relevant if combined with anotoment of the same category	TS T: theory or principl E: earlier patent doc after the filing da	le underlying the cument, but pul ate in the application	e invention olished on, or	